Low-power dual inverter with open-drain output

Rev. 4 — 6 December 2011

Product data sheet

1. General description

The 74AUP2G06 provides two inverting buffers with open-drain output. The output of the device is an open drain and can be connected to other open-drain outputs to implement active-LOW wired-OR or active-HIGH wired-AND functions.

Schmitt-trigger action at all inputs makes the circuit tolerant to slower input rise and fall times across the entire V_{CC} range from 0.8 V to 3.6 V.

This device ensures a very low static and dynamic power consumption across the entire V_{CC} range from 0.8 V to 3.6 V.

This device is fully specified for partial Power-down applications using I_{OFF} . The I_{OFF} circuitry disables the output, preventing the damaging backflow current through the device when it is powered down.

2. Features and benefits

- Wide supply voltage range from 0.8 V to 3.6 V
- High noise immunity
- Complies with JEDEC standards:
 - JESD8-12 (0.8 V to 1.3 V)
 - ◆ JESD8-11 (0.9 V to 1.65 V)
 - JESD8-7 (1.2 V to 1.95 V)
 - JESD8-5 (1.8 V to 2.7 V)
 - JESD8-B (2.7 V to 3.6 V)
- ESD protection:
 - ◆ HBM JESD22-A114F Class 3A. Exceeds 5000 V
 - MM JESD22-A115-A exceeds 200 V
 - CDM JESD22-C101E exceeds 1000 V
- Low static power consumption; $I_{CC} = 0.9 \ \mu A$ (maximum)
- Latch-up performance exceeds 100 mA per JESD 78B Class II
- Inputs accept voltages up to 3.6 V
- Low noise overshoot and undershoot < 10 % of V_{CC}
- I_{OFF} circuitry provides partial Power-down mode operation
- Multiple package options
- Specified from -40 °C to +85 °C and -40 °C to +125 °C



Low-power dual inverter with open-drain output

Ordering information 3.

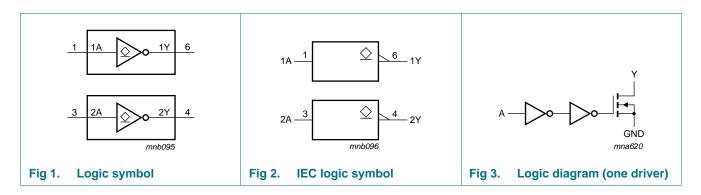
Table 1. Ordering	g information			
Type number	Package			
	Temperature range	Name	Description	Version
74AUP2G06GW	–40 °C to +125 °C	SC-88	plastic surface-mounted package; 6 leads	SOT363
74AUP2G06GM	–40 °C to +125 °C	XSON6	plastic extremely thin small outline package; no leads; 6 terminals; body 1 \times 1.45 \times 0.5 mm	SOT886
74AUP2G06GF	–40 °C to +125 °C	XSON6	plastic extremely thin small outline package; no leads; 6 terminals; body 1 \times 1 \times 0.5 mm	SOT891
74AUP2G06GN	–40 °C to +125 °C	XSON6	extremely thin small outline package; no leads; 6 terminals; body $0.9 \times 1.0 \times 0.35$ mm	SOT1115
74AUP2G06GS	–40 °C to +125 °C	XSON6	extremely thin small outline package; no leads; 6 terminals; body $1.0 \times 1.0 \times 0.35$ mm	SOT1202

Marking 4.

Table 2. Marking	
Type number	Marking code ^[1]
74AUP2G06GW	p6
74AUP2G06GM	р6
74AUP2G06GF	p6
74AUP2G06GN	р6
74AUP2G06GS	р6

The pin 1 indicator is located on the lower left corner of the device, below the marking code. [1]

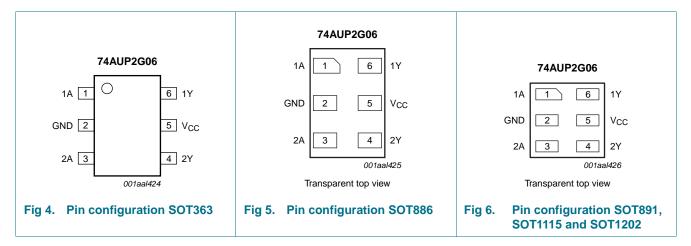
Functional diagram 5.



Low-power dual inverter with open-drain output

6. Pinning information

6.1 Pinning



6.2 Pin description

Table 3.	Pin description	
Symbol	Pin	Description
1A, 2A	1, 3	data input
GND	2	ground (0 V)
1Y, 2Y	6, 4	data output
V _{CC}	5	supply voltage

7. Functional description

7.1 Function table

Table 4.	Function table ^[1]	
Input nA		Output nY
L		Z
Н		L

[1] H = HIGH voltage level; L = LOW voltage level; Z = high-impedance OFF-state.

Low-power dual inverter with open-drain output

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		-0.5	+4.6	V
I _{IK}	input clamping current	V _I < 0 V	-50	-	mA
VI	input voltage		<u>[1]</u> –0.5	+4.6	V
I _{OK}	output clamping current	V _O < 0 V	-50	-	mA
Vo	output voltage	Active mode and Power-down mode	<u>[1]</u> –0.5	+4.6	V
lo	output current	$V_{O} = 0 V$ to V_{CC}	-	+20	mA
I _{CC}	supply current		-	+50	mA
I _{GND}	ground current		-50	-	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	$T_{amb} = -40 \ ^{\circ}C$ to +125 $^{\circ}C$	[2] _	250	mW

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] For SC-88 package: above 87.5 °C the value of Ptot derates linearly with 4.0 mW/K.

For XSON6 packages: above 118 °C the value of Ptot derates linearly with 7.8 mW/K.

9. Recommended operating conditions

Table 6. **Recommended operating conditions** Symbol Conditions Unit Parameter Min Max supply voltage 0.8 3.6 V_{CC} ٧ Vı input voltage 0 3.6 V Vo output voltage Active mode 0 V Vcc Power-down mode; V_{CC} = 0 V 0 3.6 V Tamb ambient temperature -40 +125 °C $\Delta t / \Delta V$ input transition rise and fall rate V_{CC} = 0.8 V to 3.6 V 0 200 ns/V

10. Static characteristics

Table 7. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
T _{amb} = 2	5 °C					
V _{IH}	HIGH-level input voltage	$V_{CC} = 0.8 V$	$0.70 \times V_{CC}$	-	-	V
		$V_{CC} = 0.9 \text{ V} \text{ to } 1.95 \text{ V}$	$0.65 \times V_{CC}$	-	-	V
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	1.6	-	-	V
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	2.0	-	-	V
V _{IL}	LOW-level input voltage	$V_{CC} = 0.8 V$	-	-	$0.30\times V_{CC}$	V
		$V_{CC} = 0.9 V$ to 1.95 V	-	-	$0.35\times V_{CC}$	V
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	-	-	0.7	V
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	-	-	0.9	V
74AUP2G06		All information provided in this document is subject to legal disclaimers			© NXP B.V. 2011. All rig	hts reserved
Droduct d	lata chaot	Boy 4 6 December 2011				1

NXP Semiconductors

74AUP2G06

Low-power dual inverter with open-drain output

Table 7. Static characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{OL}	LOW-level output voltage	$V_I = V_{IH} \text{ or } V_{IL}$				
		I_{O} = 20 $\mu A;$ V_{CC} = 0.8 V to 3.6 V	-	-	0.1	V
		$I_{O} = 1.1 \text{ mA}; V_{CC} = 1.1 \text{ V}$	-	-	$0.3 \times V_{CC}$	V
		$I_0 = 1.7 \text{ mA}; V_{CC} = 1.4 \text{ V}$	-	-	0.31	V
		I_{O} = 1.9 mA; V_{CC} = 1.65 V	-	-	0.31	V
		I_{O} = 2.3 mA; V_{CC} = 2.3 V	-	-	0.31	V
		I_{O} = 3.1 mA; V_{CC} = 2.3 V	-	-	0.44	V
		I_{O} = 2.7 mA; V_{CC} = 3.0 V	-	-	0.31	V
		$I_0 = 4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.44	V
l _I	input leakage current	$V_I = GND$ to 3.6 V; $V_{CC} = 0$ V to 3.6 V	-	-	±0.1	μΑ
oz	OFF-state output current	$V_{I} = V_{IL}$; $V_{O} = 0$ V to 3.6 V; $V_{CC} = 0$ V to 3.6 V	-	-	±0.1	μA
OFF	power-off leakage current	V_1 or $V_0 = 0$ V to 3.6 V; $V_{CC} = 0$ V	-	-	±0.2	μΑ
ΔI_{OFF}	additional power-off leakage current	V_1 or $V_0 = 0$ V to 3.6 V; $V_{CC} = 0$ V to 0.2 V	-	-	±0.2	μA
СС	supply current	$V_{I} = GND \text{ or } V_{CC}; I_{O} = 0 \text{ A};$ $V_{CC} = 0.8 \text{ V to } 3.6 \text{ V}$	-	-	0.5	μA
∆l _{CC}	additional supply current	$V_{I} = V_{CC} - 0.6 \text{ V}; I_{O} = 0 \text{ A}; V_{CC} = 3.3 \text{ V}$	-	-	40	μΑ
CI	input capacitance	V_{CC} = 0 V to 3.6 V; V_{I} = GND or V_{CC}	-	0.8	-	pF
Co	output capacitance	output enabled; $V_0 = GND$; $V_{CC} = 0 V$	-	1.7	-	pF
		output disabled; $V_0 = GND$; $V_{CC} = 0 V$	-	1.1	-	pF
T _{amb} = –	40 °C to +85 °C					
V _{IH}	HIGH-level input voltage	$V_{CC} = 0.8 V$	$0.70 \times V_{\text{CC}}$	-	-	V
		$V_{CC} = 0.9 V$ to 1.95 V	$0.65 \times V_{CC}$	-	-	V
		V_{CC} = 2.3 V to 2.7 V	1.6	-	-	V
		V_{CC} = 3.0 V to 3.6 V	2.0	-	-	V
√ _{IL}	LOW-level input voltage	$V_{CC} = 0.8 V$	-	-	$0.30 \times V_{CC}$	V
		$V_{CC} = 0.9 V$ to 1.95 V	-	-	$0.35 \times V_{CC}$	V
		V_{CC} = 2.3 V to 2.7 V	-	-	0.7	V
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	-	-	0.9	V
/ _{OL}	LOW-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$				
		I_{O} = 20 μ A; V_{CC} = 0.8 V to 3.6 V	-	-	0.1	V
		I _O = 1.1 mA; V _{CC} = 1.1 V	-	-	$0.3 \times V_{CC}$	V
		$I_0 = 1.7 \text{ mA}; V_{CC} = 1.4 \text{ V}$	-	-	0.37	V
		I _O = 1.9 mA; V _{CC} = 1.65 V	-	-	0.35	V
		I_{O} = 2.3 mA; V_{CC} = 2.3 V	-	-	0.33	V
		$I_{O} = 3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.45	V
		I_{O} = 2.7 mA; V_{CC} = 3.0 V	-	-	0.33	V
		I_{O} = 4.0 mA; V_{CC} = 3.0 V	-	-	0.45	V
1	input leakage current	$V_{I} = GND$ to 3.6 V; $V_{CC} = 0$ V to 3.6 V	-	-	±0.5	μA

Low-power dual inverter with open-drain output

Symbol Parameter Conditions Max Unit Min Тур OFF-state output current $V_{I} = V_{II}$; $V_{O} = 0$ V to 3.6 V; ±0.5 μA loz -- $V_{CC} = 0 V \text{ to } 3.6 V$ power-off leakage current V_{I} or $V_{O} = 0$ V to 3.6 V; $V_{CC} = 0$ V ±0.5 **I**OFF μΑ - V_{1} or $V_{0} = 0$ V to 3.6 V; additional power-off ±0.6 ΔI_{OFF} μΑ -_ $V_{CC} = 0 V \text{ to } 0.2 V$ leakage current supply current $V_I = GND \text{ or } V_{CC}; I_O = 0 \text{ A};$ 0.9 I_{CC} μA -- $V_{CC} = 0.8 V$ to 3.6 V additional supply current V_{I} = V_{CC} - 0.6 V; I_{O} = 0 A; V_{CC} = 3.3 V 50 ΔI_{CC} -μΑ T_{amb} = -40 °C to +125 °C HIGH-level input voltage $V_{CC} = 0.8 V$ $0.75 \times V_{CC}$ -V VIH $V_{CC} = 0.9 V$ to 1.95 V $0.70 \times V_{CC}$ --V $V_{CC} = 2.3 \text{ V}$ to 2.7 V V 1.6 -- $V_{CC} = 3.0 \text{ V}$ to 3.6 V 2.0 V _ VIL LOW-level input voltage $V_{CC} = 0.8 V$ _ - $0.25 \times V_{CC}$ V $V_{CC} = 0.9 \text{ V}$ to 1.95 V $0.30 \times V_{CC} \ V$ -- $V_{CC} = 2.3 \text{ V} \text{ to } 2.7 \text{ V}$ 0.7 V -- $V_{CC} = 3.0 \text{ V}$ to 3.6 V 0.9 V --LOW-level output voltage $V_I = V_{IH} \text{ or } V_{IL}$ VOL $I_{O} = 20 \ \mu A$; $V_{CC} = 0.8 \ V$ to 3.6 V V 0.11 -_ $I_0 = 1.1 \text{ mA}; V_{CC} = 1.1 \text{ V}$ $0.33 \times V_{CC}$ V _ - $I_0 = 1.7 \text{ mA}; V_{CC} = 1.4 \text{ V}$ 0.41 V -- $I_0 = 1.9 \text{ mA}; V_{CC} = 1.65 \text{ V}$ 0.39 V -- $I_0 = 2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$ 0.36 V --0.50 $I_0 = 3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$ V -- $I_0 = 2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$ 0.36 V -- $I_0 = 4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$ 0.50 V -input leakage current $V_{I} = GND$ to 3.6 V; $V_{CC} = 0$ V to 3.6 V I_L -±0.75 μΑ - $V_{I} = V_{IL}; V_{O} = 0 V \text{ to } 3.6 V;$ OFF-state output current ±0.75 μΑ I_{OZ} - $V_{CC} = 0 V \text{ to } 3.6 V$ power-off leakage current V_{I} or $V_{O} = 0$ V to 3.6 V; $V_{CC} = 0$ V ±0.75 μΑ **I**OFF -additional power-off V_{1} or $V_{0} = 0$ V to 3.6 V; ΔI_{OFF} ±0.75 μΑ -- $V_{CC} = 0 V \text{ to } 0.2 V$ leakage current $V_I = GND \text{ or } V_{CC}; I_O = 0 \text{ A};$ μΑ I_{CC} supply current 1.4 - $V_{CC} = 0.8 V$ to 3.6 V additional supply current $V_{I} = V_{CC} - 0.6 \text{ V}; I_{O} = 0 \text{ A}; V_{CC} = 3.3 \text{ V}$ 75 ΔI_{CC} μΑ -

Static characteristics ... continued Table 7.

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Low-power dual inverter with open-drain output

11. Dynamic characteristics

Table 8. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 8.

Symbo	Parameter	Conditions		25 °C		-40	0 °C to +1	25 °C	Unit
			Min	Typ[1]	Max	Min	Max (85 °C)	Max (125 °C)	
C _L = 5	pF								
t _{pd}	propagation delay	nA to nY; see <u>Figure 7</u>	[2]						
		$V_{CC} = 0.8 V$	-	12.8	-	-	-	-	ns
		$V_{CC} = 1.1 \text{ V to } 1.3 \text{ V}$	2.3	4.3	9.9	2.0	10.9	12.0	ns
		$V_{CC} = 1.4 \text{ V} \text{ to } 1.6 \text{ V}$	1.8	3.1	6.1	1.5	7.1	7.8	ns
		V_{CC} = 1.65 V to 1.95 V	1.5	2.8	4.7	1.2	5.7	6.3	ns
		V_{CC} = 2.3 V to 2.7 V	1.2	2.2	3.2	1.0	3.9	4.3	ns
		V_{CC} = 3.0 V to 3.6 V	1.1	2.2	3.3	0.8	3.6	4.0	ns
C _L = 10) pF								
t _{pd}	propagation delay	nA to nY; see Figure 7	[2]						
		$V_{CC} = 0.8 V$	-	15.8	-	-	-	-	ns
		$V_{CC} = 1.1 \text{ V to } 1.3 \text{ V}$	2.7	5.4	11.2	2.5	13.2	15.0	ns
		$V_{CC} = 1.4 \text{ V} \text{ to } 1.6 \text{ V}$	2.2	3.9	7.0	2.0	8.5	9.4	ns
		V_{CC} = 1.65 V to 1.95 V	1.9	3.6	5.4	1.7	6.7	7.4	ns
		V_{CC} = 2.3 V to 2.7 V	1.7	2.9	3.8	1.4	4.5	5.0	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	1.6	3.2	4.6	1.2	4.9	5.4	ns
C _L = 15	ρ F								
t _{pd}	propagation delay	nA to nY; see <u>Figure 7</u>	[2]						
		$V_{CC} = 0.8 V$	-	18.8	-	-	-	-	ns
		$V_{CC} = 1.1 \text{ V to } 1.3 \text{ V}$	3.2	6.4	12.2	2.9	15.2	17.0	ns
		$V_{CC} = 1.4 \text{ V} \text{ to } 1.6 \text{ V}$	2.6	4.6	7.7	2.3	9.4	10.0	ns
		V_{CC} = 1.65 V to 1.95 V	2.3	4.5	6.6	2.1	7.3	8.1	ns
		V_{CC} = 2.3 V to 2.7 V	2.1	3.5	4.6	1.7	5.1	5.7	ns
		V_{CC} = 3.0 V to 3.6 V	2.0	4.0	6.0	1.5	6.5	7.2	ns
C _L = 30) pF								
t _{pd}	propagation delay	nA to nY; see <u>Figure 7</u>	[2]						
		$V_{CC} = 0.8 V$	-	27.8	-	-	-	-	ns
		$V_{CC} = 1.1 \text{ V} \text{ to } 1.3 \text{ V}$	4.4	9.3	16.5	3.9	19.3	21.3	ns
		$V_{CC} = 1.4 \text{ V} \text{ to } 1.6 \text{ V}$	3.6	6.8	10.1	3.2	12.0	13.2	ns
		V_{CC} = 1.65 V to 1.95 V	3.2	6.8	10.7	2.9	11.0	12.1	ns
		V_{CC} = 2.3 V to 2.7 V	2.9	5.3	7.2	2.6	7.8	8.6	ns
		V_{CC} = 3.0 V to 3.6 V	2.9	6.5	10.5	2.5	10.8	11.9	ns

74AUP2G06 Product data sheet

Low-power dual inverter with open-drain output

Symbol	Parameter	arameter Conditions		25 °C			–40 °C to +125 °C		
			Min	Typ <mark>[1]</mark>	Мах	Min	Max (85 °C)	Max (125 °C)	
C _L = 5 pl	F, 10 pF, 15 pF and	30 pF							
C _{PD}	power dissipation	$f_i = 1 \text{ MHz}; V_i = \text{GND to } V_{CC}$ [3]							
	capacitance	$V_{CC} = 0.8 V$	-	0.5	-	-	-	-	pF
		$V_{CC} = 1.1 \text{ V} \text{ to } 1.3 \text{ V}$	-	0.6	-	-	-	-	pF
		$V_{CC} = 1.4 \text{ V} \text{ to } 1.6 \text{ V}$	-	0.7	-	-	-	-	pF
		$V_{CC} = 1.65 \text{ V} \text{ to } 1.95 \text{ V}$	-	0.7	-	-	-	-	pF
		V_{CC} = 2.3 V to 2.7 V	-	1.0	-	-	-	-	pF
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	-	1.2	-	-	-	-	pF

Dynamic characteristics ... continued Table 8.

[1] All typical values are measured at nominal V_{CC} .

[2] t_{pd} is the same as t_{PZL} and t_{PLZ} .

[3] C_{PD} is used to determine the dynamic power dissipation (P_D in μ W).

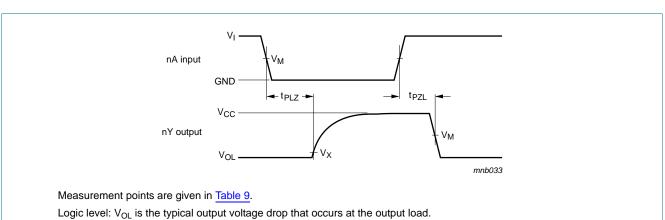
 P_{D} = $C_{PD} \times V_{CC}{}^2 \times f_i \times N$ where:

 f_i = input frequency in MHz;

V_{CC} = supply voltage in V;

N = number of inputs switching.

12. Waveforms



The data input (nA) to output (nY) propagation delays Fig 7.

Table 9. **Measurement points**

Supply voltage	Input	Output	
V _{cc}	V _M	V _M	V _X
0.8 V to 1.6 V	$0.5 imes V_{CC}$	$0.5 imes V_{CC}$	V _{OL} + 0.1 V
1.65 V to 2.7 V	$0.5\times V_{CC}$	$0.5\times V_{CC}$	V _{OL} + 0.15 V
3.0 V to 3.6 V	$0.5\times V_{CC}$	$0.5\times V_{CC}$	V _{OL} + 0.3 V

Low-power dual inverter with open-drain output

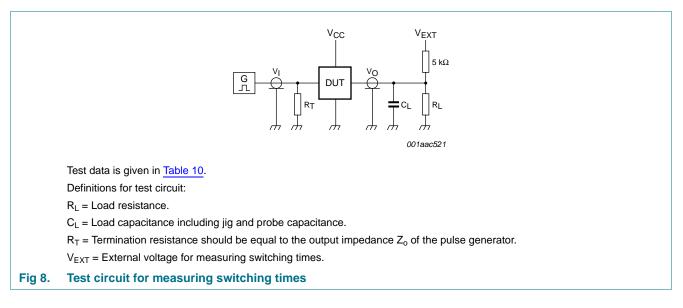


Table 10. Test data

Supply voltage	Load		V _{EXT}		
V _{cc}	CL	R _L [1]	t _{PLH} , t _{PHL}	t _{PZH} , t _{PHZ}	t _{PZL} , t _{PLZ}
0.8 V to 3.6 V	5 pF, 10 pF, 15 pF and 30 pF	5 k Ω or 1 M Ω	open	GND	$2 \times V_{CC}$

[1] For measuring enable and disable times $R_L = 5 k\Omega$, for measuring propagation delays, setup and hold times and pulse width $R_L = 1 M\Omega$.

NXP Semiconductors

74AUP2G06

Low-power dual inverter with open-drain output

13. Package outline

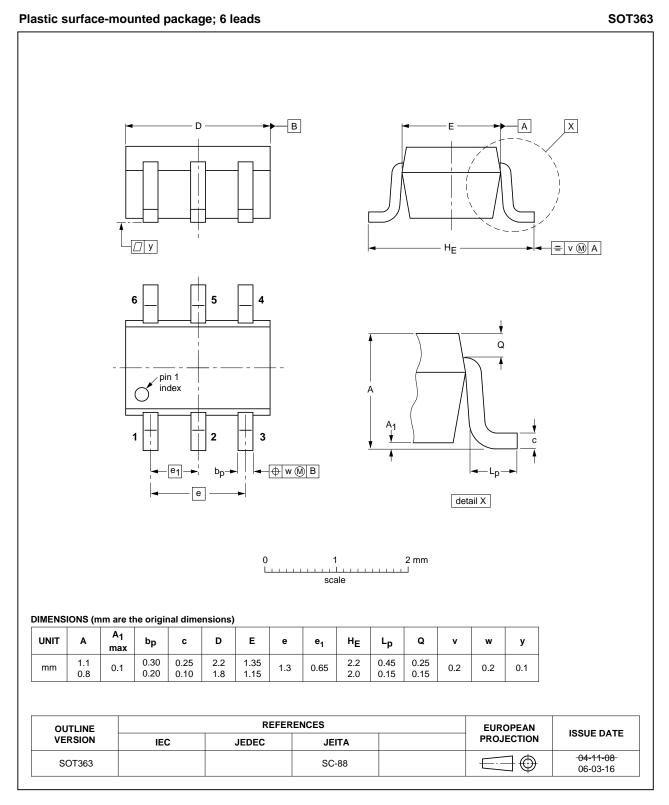


Fig 9. Package outline SOT363 (SC-88)

All information provided in this document is subject to legal disclaimers.

Low-power dual inverter with open-drain output

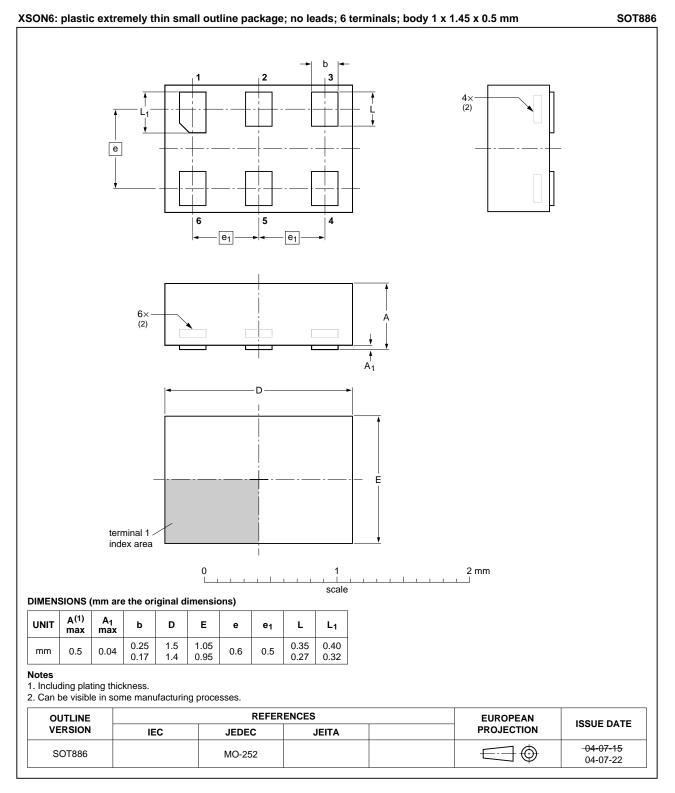


Fig 10. Package outline SOT886 (XSON6)

All information provided in this document is subject to legal disclaimers.

Low-power dual inverter with open-drain output

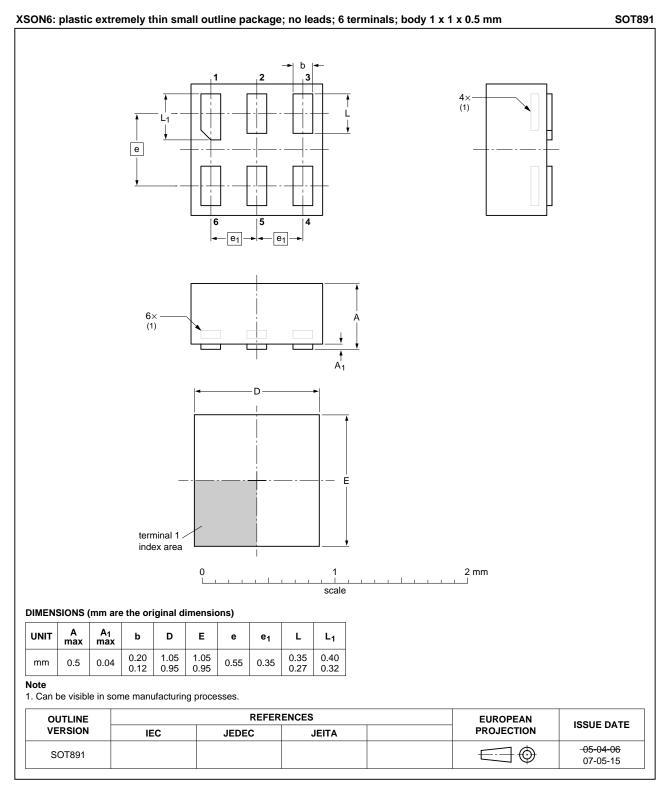
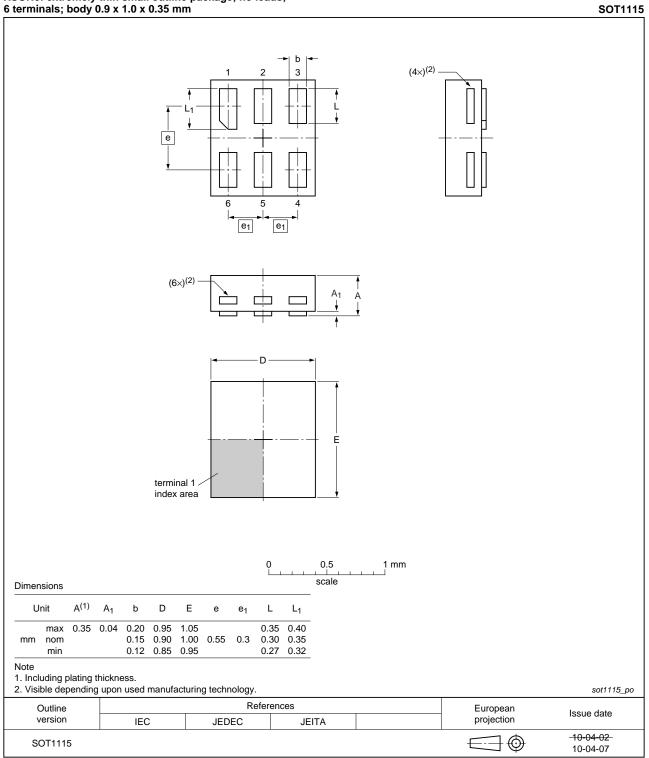


Fig 11. Package outline SOT891 (XSON6)

All information provided in this document is subject to legal disclaimers.

Low-power dual inverter with open-drain output

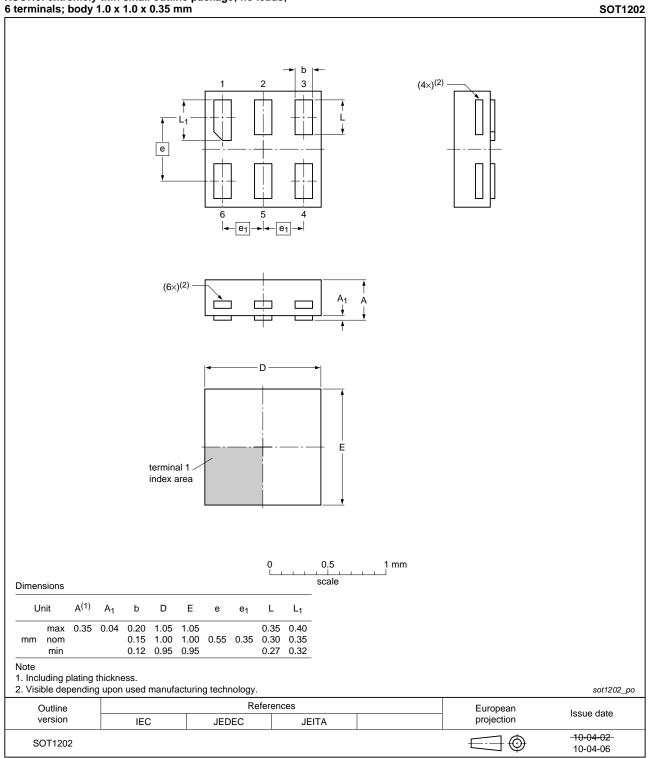


XSON6: extremely thin small outline package; no leads; 6 terminals; body 0.9 x 1.0 x 0.35 mm

Fig 12. Package outline SOT1115 (XSON6)

All information provided in this document is subject to legal disclaimers.

Low-power dual inverter with open-drain output



XSON6: extremely thin small outline package; no leads; 6 terminals; body 1.0 x 1.0 x 0.35 mm

Fig 13. Package outline SOT1202 (XSON6)

All information provided in this document is subject to legal disclaimers.

Low-power dual inverter with open-drain output

14. Abbreviations

	ription Jed Device Model
	ed Device Model
DUT Device	
	e Under Test
ESD Electro	oStatic Discharge
HBM Humar	n Body Model
MM Machir	ne Model

15. Revision history

Table 12.Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74AUP2G06 v.4	20111206	Product data sheet	-	74AUP2G06 v.3
Modifications:	 Legal page 	s updated.		
74AUP2G06 v.3	20101026	Product data sheet	-	74AUP2G06 v.2
74AUP2G06 v.2	20100325	Product data sheet	-	74AUP2G06 v.1
74AUP2G06 v.1	20100211	Product data sheet	-	-

Low-power dual inverter with open-drain output

16. Legal information

16.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

16.2 Definitions

Draft — The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. NXP Semiconductors does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

Short data sheet — A short data sheet is an extract from a full data sheet with the same product type number(s) and title. A short data sheet is intended for quick reference only and should not be relied upon to contain detailed and full information. For detailed and full information see the relevant full data sheet, which is available on request via the local NXP Semiconductors sales office. In case of any inconsistency or conflict with the short data sheet, the full data sheet shall prevail.

Product specification — The information and data provided in a Product data sheet shall define the specification of the product as agreed between NXP Semiconductors and its customer, unless NXP Semiconductors and customer have explicitly agreed otherwise in writing. In no event however, shall an agreement be valid in which the NXP Semiconductors product is deemed to offer functions and qualities beyond those described in the Product data sheet.

16.3 Disclaimers

Limited warranty and liability — Information in this document is believed to be accurate and reliable. However, NXP Semiconductors does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information.

In no event shall NXP Semiconductors be liable for any indirect, incidental, punitive, special or consequential damages (including - without limitation - lost profits, lost savings, business interruption, costs related to the removal or replacement of any products or rework charges) whether or not such damages are based on tort (including negligence), warranty, breach of contract or any other legal theory.

Notwithstanding any damages that customer might incur for any reason whatsoever, NXP Semiconductors' aggregate and cumulative liability towards customer for the products described herein shall be limited in accordance with the *Terms and conditions of commercial sale* of NXP Semiconductors.

Right to make changes — NXP Semiconductors reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

Suitability for use — NXP Semiconductors products are not designed, authorized or warranted to be suitable for use in life support, life-critical or safety-critical systems or equipment, nor in applications where failure or malfunction of an NXP Semiconductors product can reasonably be expected to result in personal injury, death or severe property or environmental damage. NXP Semiconductors accepts no liability for inclusion and/or use of NXP Semiconductors products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

Applications — Applications that are described herein for any of these products are for illustrative purposes only. NXP Semiconductors makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Customers are responsible for the design and operation of their applications and products using NXP Semiconductors products, and NXP Semiconductors accepts no liability for any assistance with applications or customer product design. It is customer's sole responsibility to determine whether the NXP Semiconductors product is suitable and fit for the customer's applications and products planned, as well as for the planned application and use of customer's third party customer(s). Customers should provide appropriate design and operating safeguards to minimize the risks associated with their applications and products.

NXP Semiconductors does not accept any liability related to any default, damage, costs or problem which is based on any weakness or default in the customer's applications or products, or the application or use by customer's third party customer(s). Customer is responsible for doing all necessary testing for the customer's applications and products using NXP Semiconductors products in order to avoid a default of the applications and the products or of the application or use by customer's third party customer(s). NXP does not accept any liability in this respect.

Limiting values — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) will cause permanent damage to the device. Limiting values are stress ratings only and (proper) operation of the device at these or any other conditions above those given in the Recommended operating conditions section (if present) or the Characteristics sections of this document is not warranted. Constant or repeated exposure to limiting values will permanently and irreversibly affect the quality and reliability of the device.

Terms and conditions of commercial sale — NXP Semiconductors products are sold subject to the general terms and conditions of commercial sale, as published at http://www.nxp.com/profile/terms, unless otherwise agreed in a valid written individual agreement. In case an individual agreement is concluded only the terms and conditions of the respective agreement shall apply. NXP Semiconductors hereby expressly objects to applying the customer's general terms and conditions with regard to the purchase of NXP Semiconductors products by customer.

No offer to sell or license — Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

Export control — This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from competent authorities.

© NXP B.V. 2011. All rights reserved.

Low-power dual inverter with open-drain output

Non-automotive qualified products — Unless this data sheet expressly states that this specific NXP Semiconductors product is automotive qualified, the product is not suitable for automotive use. It is neither qualified nor tested in accordance with automotive testing or application requirements. NXP Semiconductors accepts no liability for inclusion and/or use of non-automotive qualified products in automotive equipment or applications.

In the event that customer uses the product for design-in and use in automotive applications to automotive specifications and standards, customer (a) shall use the product without NXP Semiconductors' warranty of the product for such automotive applications, use and specifications, and (b) whenever customer uses the product for automotive applications beyond

17. Contact information

NXP Semiconductors' specifications such use shall be solely at customer's own risk, and (c) customer fully indemnifies NXP Semiconductors for any liability, damages or failed product claims resulting from customer design and use of the product for automotive applications beyond NXP Semiconductors' standard warranty and NXP Semiconductors' product specifications.

16.4 Trademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.

For more information, please visit: http://www.nxp.com

For sales office addresses, please send an email to: salesaddresses@nxp.com

Low-power dual inverter with open-drain output

18. Contents

1	General description 1
2	Features and benefits 1
3	Ordering information 2
4	Marking 2
5	Functional diagram 2
6	Pinning information 3
6.1	Pinning 3
6.2	Pin description 3
7	Functional description 3
7.1	Function table 3
8	Limiting values 4
9	Recommended operating conditions 4
10	Static characteristics 4
11	Dynamic characteristics7
12	Waveforms
13	Package outline 10
14	Abbreviations 15
15	Revision history 15
16	Legal information 16
16.1	Data sheet status 16
16.2	Definitions 16
16.3	Disclaimers 16
16.4	Trademarks 17
17	Contact information 17
18	Contents

Please be aware that important notices concerning this document and the product(s) described herein, have been included in section 'Legal information'.

© NXP B.V. 2011.

All rights reserved.

For more information, please visit: http://www.nxp.com For sales office addresses, please send an email to: salesaddresses@nxp.com

Date of release: 6 December 2011 Document identifier: 74AUP2G06